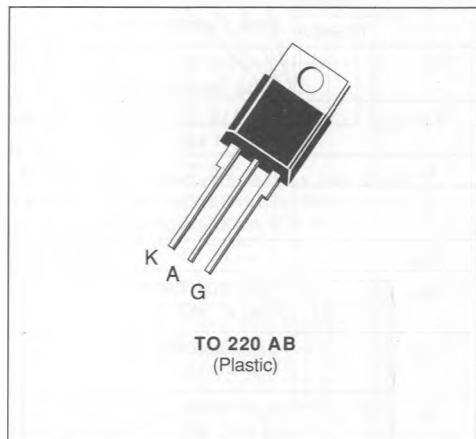


## SENSITIVE GATE THYRISTORS

- OPERATES DIRECTLY FROM LOW SIGNAL
- GLASS PASSIVATED CHIP
- POSSIBILITY OF MOUNTING ON PRINTED CIRCUIT



### ABSOLUTE RATINGS (limiting values)

Symbol	Parameter	Value		Unit
$I_T$ (RMS)	RMS on-state Current (1)	$T_c = 90^\circ\text{C}$	4	A
$I_T$ (AV)	Mean on-state Current (1)	$T_c = 90^\circ\text{C}$	2.5	A
$I_{TSM}$	Non Repetitive Surge Peak on-state Current ( $T_j$ initial = 25 °C) (2)	$t = 8.3 \text{ ms}$	52	A
		$t = 10 \text{ ms}$	50	
$I^2t$	$I^2t$ Value for Fusing	$t = 10 \text{ ms}$	12.5	$\text{A}^2\text{s}$
$di/dt$	Critical Rate of Rise of on-state Current (3)		100	$\text{A}/\mu\text{s}$
$T_{stg}$ $T_j$	Storage and Operating Junction Temperature Range	$-40 \text{ to } 110^\circ\text{C}$		$^\circ\text{C}$
		$-40 \text{ to } 110^\circ\text{C}$		$^\circ\text{C}$

Symbol	Parameter	TYS406-.. or TYS407-..						Unit
		05	1	2	4	6	8	
$V_{DRM}$ $V_{RRM}$	Repetitive Peak off-state Voltage (4)	50	100	200	400	600	800	V

(1) Single phase circuit, 180° conduction angle.

(2) Half sine wave.

(3)  $I_g = 5 \text{ mA}$     $di/dt = 1 \text{ A}/\mu\text{s}$ .

(4)  $T_j = 110^\circ\text{C}$     $R_{GK} = 1 \text{ k}\Omega$ .

### THERMAL RESISTANCES

Symbol	Parameter	Value		Unit
$R_{th} (j - c)$	Junction-case for DC	5.5		$^\circ\text{C}/\text{W}$
$R_{th} (j - a)$	Junction-ambient	60		$^\circ\text{C}/\text{W}$

## **GATE CHARACTERISTICS** (maximum values)

$$P_{GM} = 20 \text{ W } (t_D = 20 \mu\text{s})$$

$$I_{FGM} = 2 \text{ A} \quad (t_0 = 20 \text{ } \mu\text{s})$$

$$V_{RGM} = 5 \text{ V}$$

$$P_G(\text{Av}) = 0.5 \text{ W}$$

$V_{EGM} = 15 \text{ V}$  ( $t_0 = 20 \mu\text{s}$ )

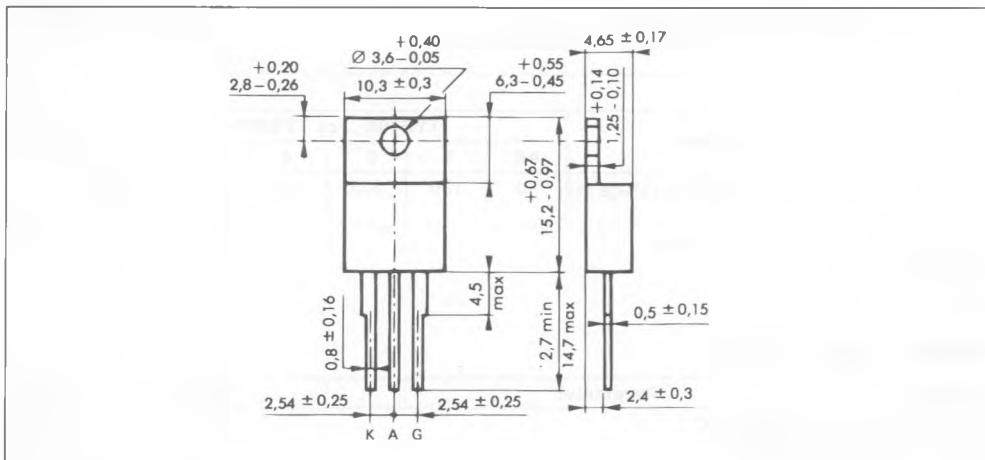
## ELECTRICAL CHARACTERISTICS

Symbol	Types	Test Conditions			Min.	Typ.	Max.	Unit
$I_{GT}$	TYS406	$T_j = 25^\circ C$	$V_D = 12 V$	$R_L = 140 \Omega$			0.2	mA
	TYS407	Pulse Duration > 20 $\mu s$					0.5	
$V_{GT}$		$T_j = 25^\circ C$	$V_D = 12 V$	$R_L = 140 \Omega$			1.5	V
$V_{GD}$		$T_j = 110^\circ C$	$V_D = V_{DRM}$	$R_L = 3.3 k\Omega$	0.1			V
$I_H$		$T_j = 25^\circ C$	$I_T = 50 mA$	$R_{GK} = 1 k\Omega$			6	mA
$I_L$		$T_j = 25^\circ C$	$V_D = 12 V$	$I_G = 10 mA$		10		mA
		Pulse Duration > 20 $\mu s$		$R_{GK} = 1 k\Omega$				
$V_{TM}$		$T_j = 25^\circ C$	$I_{TM} = 8 A$	$t_p = 10 ms$			1.6	V
$I_{DRM}$	$V_{DRM}$ specified $R_{GK} = 1 k\Omega$			$T_j = 25^\circ C$			0.01	mA
				$T_j = 110^\circ C$			0.5	
$I_{RRM}$	$V_{RRM}$ specified $R_{GK} = 1 k\Omega$			$T_j = 25^\circ C$			0.01	mA
				$T_j = 110^\circ C$			0.5	
$t_{gt}$		$T_j = 25^\circ C$	$V_D = V_{DRM}$	$I_T = 8 A$		1.5		$\mu s$
		$I_G = 10 mA$	$di_G/dt = 0.15 A/\mu s$					
$t_q$		$T_j = 110^\circ C$	$I_T = 8 A$	$V_R = 24 V$		100		$\mu s$
		$V_D = 67 \% V_{DRM}$	$di/dt = 10 A/\mu s$	$dv/dt = 10 V/\mu s$				
$dv/dt^*$		$T_j = 110^\circ C$	$R_{GK} = 1 k\Omega$			10		$V/\mu s$
		Linear Slope up to $V_D = 67 \% V_{DRM}$						

\* For higher guaranteed values, please consult us.

## PACKAGE MECHANICAL DATA

## TO 220 AB Plastic



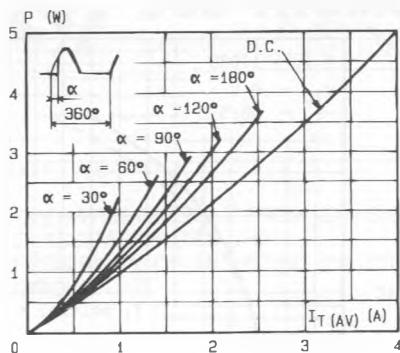


Fig.1 - Maximum mean power dissipation versus mean on-state current.

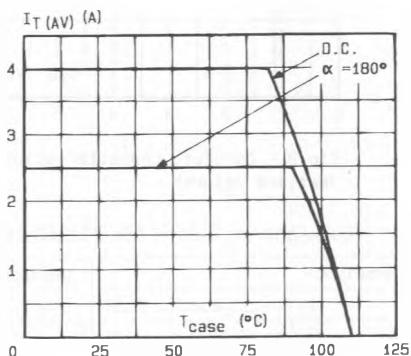


Fig.3 - Mean on-state current versus case temperature.

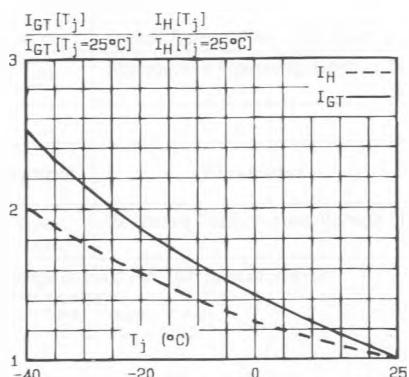


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

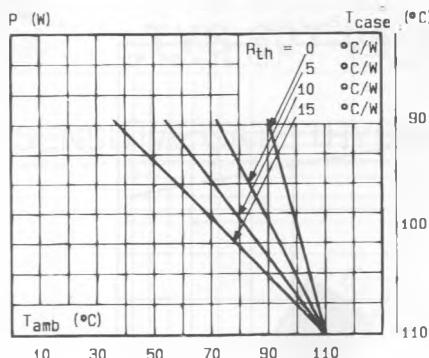


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.

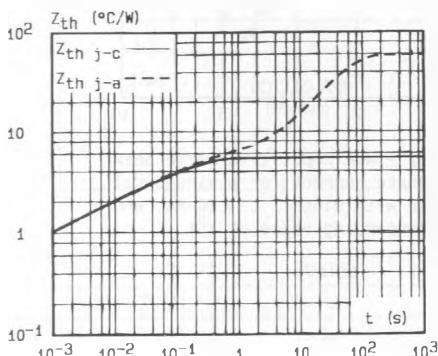


Fig.4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

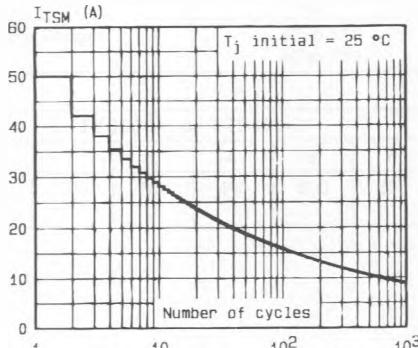


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

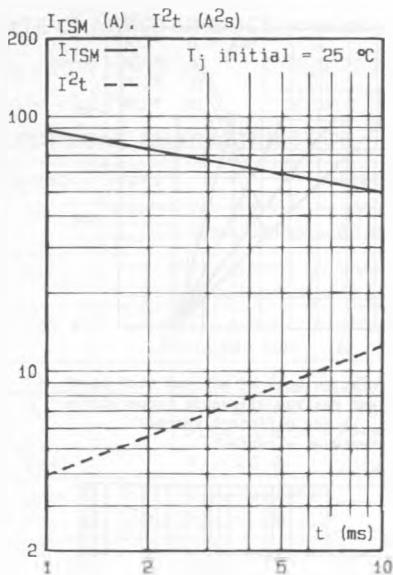


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width :  $t \leq 10$  ms, and corresponding value of  $I^2t$ .

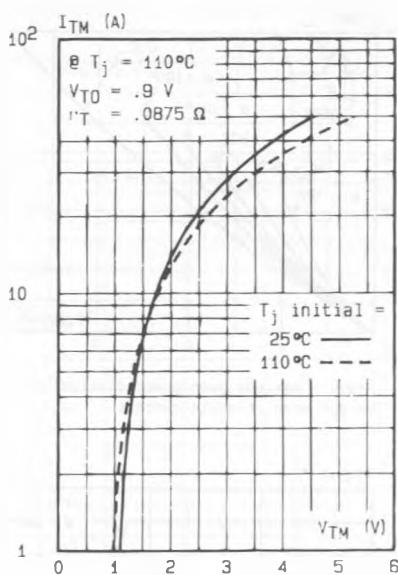


Fig.8 On-state characteristics (maximum values).